

PIN photodiode for 0.9~1.7 μ m (R&D sample)

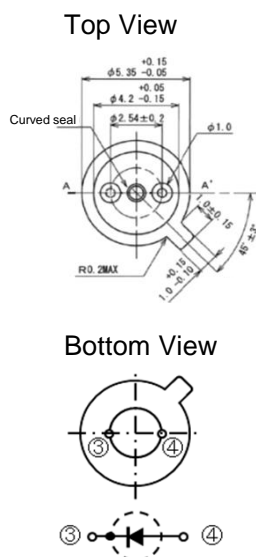
Mechanical Specifications and Materials (Unit: mm)



Package: TO-18

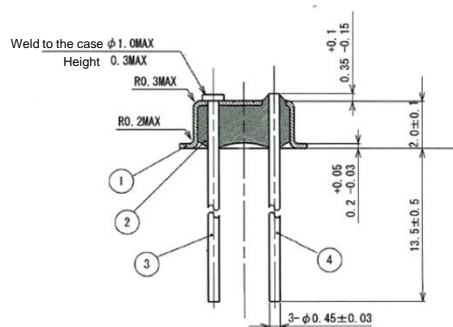
	ITEM	MATERIALS
1	STEM	SPCE, Au Plating
2	LEAD	Fe-Ni alloy, Au Plating

• Package dimensions

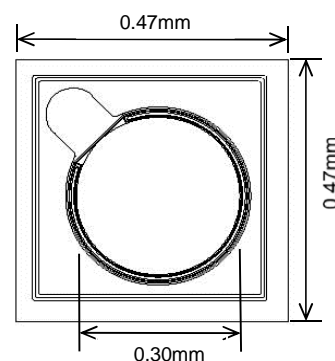


• Chip dimensions

Side View (Cross Section A-A')



Photosensitive area: 0.30mm
Thickness 0.35mm



Typical Optical-Electrical Characteristics

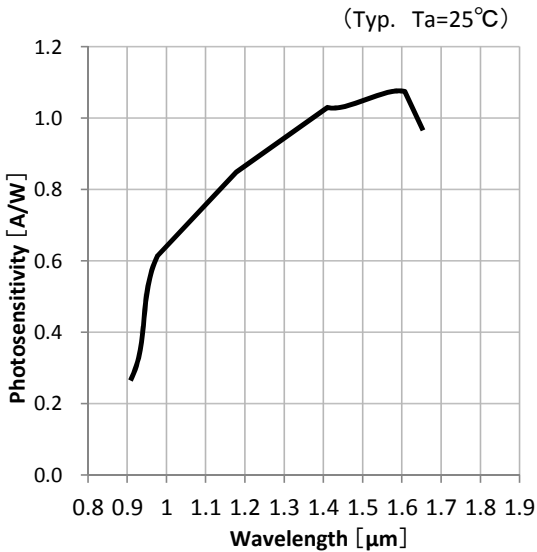
$T_a=25^\circ\text{C}$

Item	Symbol	Unit	
Spectral response range		μm	0.9 to 1.7
Peak sensitivity wavelength	ρ	μm	1.55 (Designed value)
Photosensitivity $\lambda=1.3\mu\text{m}$	S	A/W	0.9 (Typ.)
Photosensitivity $\lambda=1.55\mu\text{m}$	S	A/W	1.0 (Typ.)
Dark current ($V_R=5\text{V}$)	I_D	(nA)	0.20 (Typ.)
Temp. coefficient of dark current	$T I_D$	(nA)	T.B.D.

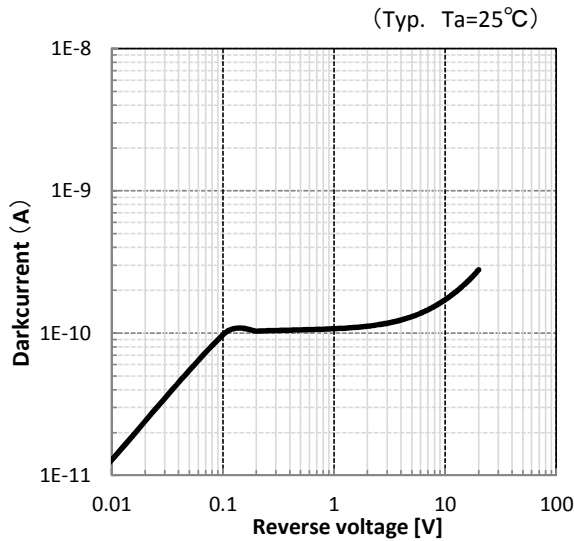
PIN photodiode for 0.9~1.7μm (R&D sample)

Typical properties

Spectral response



Dark current vs. reverse voltage



Terminal capacitance vs. voltage

